



OKI Semiconductor

FEDR27V25653L-02-01 Issue Date: Mar. 10, 2005

MR27V25653L

 $\underline{16M\text{-Word}\times 16\text{-Bit or }32M\text{-Word}\times 8\text{-Bit Page Mode }P2ROM$

FEATURES

- \cdot 16,777,216-word \times 16-bit / 33,554,432-word \times 8-bit electrically switchable configuration
- · Page size of 8-word x 16-Bit or 16-word x 8-Bit
- · 3.0 V to 3.6 V power supply

Random Access time
Page Access time
Operating current
Standby current
5 mA MAX
5 mA MAX

- · Input/Output TTL compatible
- · Three-state output

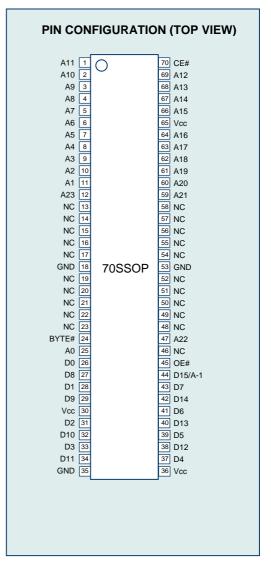
PACKAGES

· MR27V25653L-xxxMB 70-pin plastic SSOP (SSOP70-P-500-0.80-K)

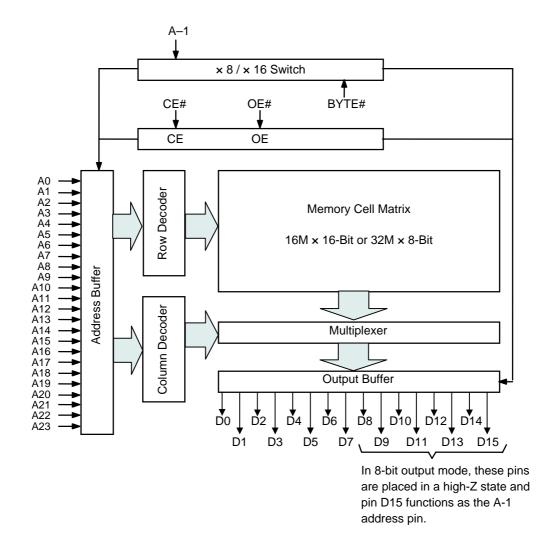
P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- · Custom Marking is available at no additional charge.



BLOCK DIAGRAM



PIN DESCRIPTIONS

Pin name	Functions
D15 / A–1	Data output / Address input
A0 to A23	Address inputs
D0 to D14	Data outputs
CE#	Chip enable input
OE#	Output enable input
BYTE#	Word / Byte select input
V _{CC}	Power supply voltage
V _{SS}	Ground
NC	No connect

FUNCTION TABLE

Mode	CE#	OE#	BYTE#	V _{CC}	D0 to D7	D8 to D14	D15/A-1
Read (16-Bit)	L	L	Н			D_OUT	
Read (8-Bit)	L	L	L	201/	D _{OUT}	Hi–Z	L/H
Output diaable		Н	Н	3.0 V		Hi–Z	
Output disable	L	П	L	to 3.6 V		⊓1–∠	*
Ctondby	ш		Н	3.0 V		Ц: 7	
Standby	Н	*	L		Hi–Z		*

^{*:} Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	_	-55 to 125	°C
Input voltage	Vı		-0.5 to V _{CC} +0.5	V
Output voltage	Vo	Relative to V _{SS}	-0.5 to V _{CC} +0.5	V
Power supply voltage	V _{CC}		-0.5 to 5	V
Power dissipation per package	P_D	Ta = 25°C	1.0	W
Output short circuit current	los	_	10	mA

RECOMMENDED OPERATING CONDITIONS

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	V _{CC}		3.0	1	3.6	V
Input "H" level	V _{IH}	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	2.2	-	V _{CC} +0.5*	V
Input "L" level	V_{IL}		-0.5**	-	0.6	V

Voltage is relative to VSS.

- *: Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

 $(V_{CC} = 3.3 \text{ V}, Ta = 25^{\circ}\text{C}, f = 1 \text{ MHz})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	\/ 0\/	_	_	10	
BYTE#	C _{IN2}	$V_1 = 0 V$	_	_	200	pF
Output	C _{OUT}	$V_O = 0 V$	_	_	10	

ELECTRICAL CHARACTERISTICS

DC Characteristics

 $(V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

			,		10 0.0 1, 10	- 0 10 70 0)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to V_{CC}	_	_	5	μΑ
Output leakage current	I_{LO}	$V_O = 0$ to V_{CC}	1	1	5	μΑ
V _{CC} power supply current	I _{ccsc}	CE# = V _{CC}	1	1	5	mA
(Standby)	Iccst	CE# = V _{IH}	1	1	5	mA
V _{CC} power supply current (Read)	I _{CCA1}	$CE\# = V_{IL}, OE\# = V_{IH}$ f=5MHz			60	mA
Input "H" level	V _{IH}	_	2.2		V _{CC} +0.5	V
Input "L" level	V_{IL}	_	-0.5**	_	0.6	V
Output "H" level	V _{OH}	$I_{OH} = -1 \text{ mA}$	2.4	_	_	V
Output "L" level	V_{OL}	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V

Voltage is relative to V_{SS} .

- * : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

AC Characteristics

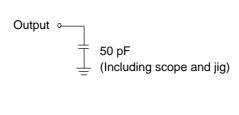
 $(V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t _C		100	ı	ns
Address access time	t _{ACC}	$CE# = OE# = V_{IL}$		100	ns
Page cycle time	t _{PC}	_	35		ns
Page access time	t _{PAC}			35	ns
CE# access time	t _{CE}	OE# = V _{IL}		100	ns
OE# access time	t _{OE}	CE# = V _{IL}		30	ns
Output disable time	t _{CHZ}	OE# = V _{IL}	0	20	ns
Output disable time	t _{OHZ}	CE# = V _{IL}	0	20	ns
Output hold time	t _{OH}	CE# = OE# = V _{IL}	0	_	ns

Measurement conditions

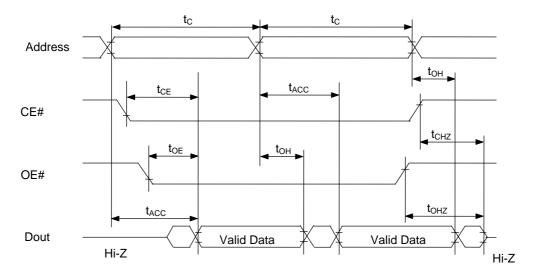
Input signal level ------ 0 V/3.0 V Input timing reference level------- 1/2Vcc Output load ------ 50 pF Output timing reference level ------ 1/2Vcc

Output load

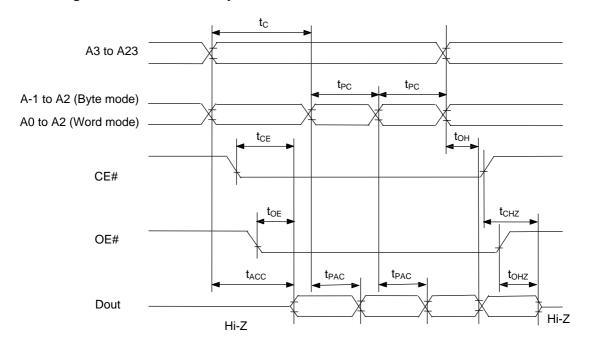


TIMING CHART (READ CYCLE)

Random Access Mode Read Cycle



Page Access Mode Read Cycle

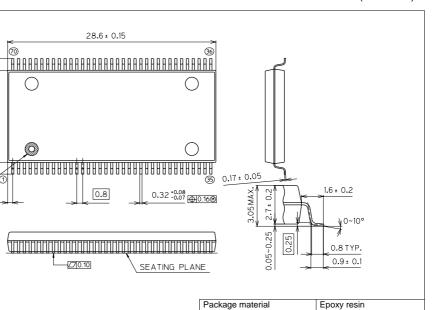


SSOP70-P-500-0.80-K

15.9 ± 0.2 12.7 ± 0.1

INDEX MARK
Mirror finish
0.7 TYP.

Oki Electric Industry Co., Ltd.



Lead frame material

Package weight (g)

Rev. No./Last Revised

Pin treatment

42 alloy

Solder plating (≥5µm)

3/Dec. 5, 1996

(Unit: mm)

Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document		Page			
No.	Date	Previous Edition	Current Edition	Description	
FEDR27V25653L-02-01	Mar. 10, 2005	-	-	Final edition 1	

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